

Description

The 5PB12xx is a high-performance TCXO/LVCMOS clock fanout buffer family with individual OE pin for each output. The CLKIN pin can accept either a square wave (LVCMOS) or clipped sine wave (such as TCXO clipped sine wave output) as input.

There are 3 different fan-out versions available: 1:3, 1:4 and 1:6.

The 5PB12xx has industry-leading low jitter and extremely low current consumption, making it ideal for smart mobile devices.

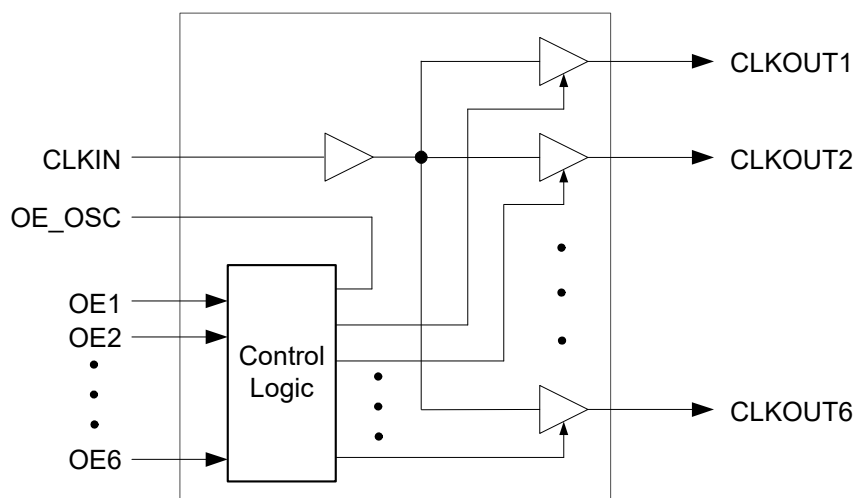
Typical Applications

- Smart Mobile Handsets
- RF and baseband peripheral clock distribution
- Automotive

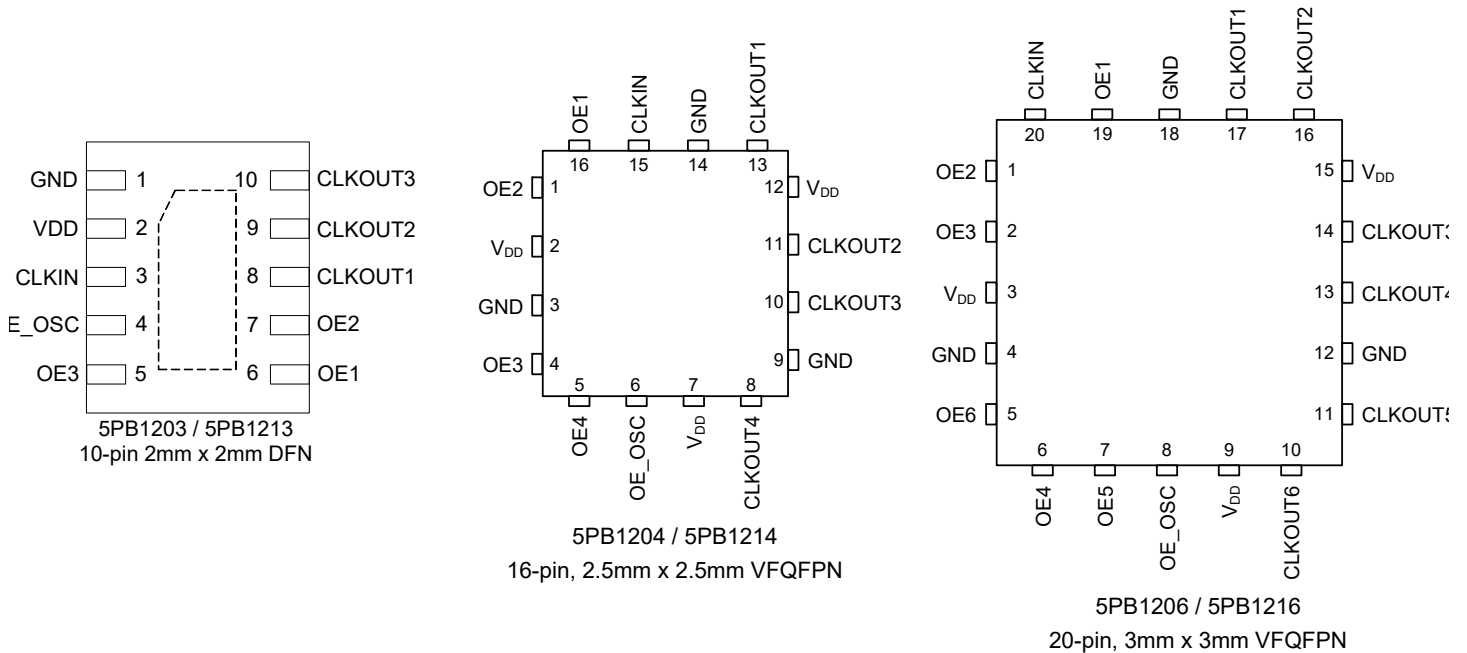
Features

- Extremely low operating and standby current consumption
- Low RMS additive phase jitter
- Family supports 1.8V to 3.3V power supply voltage:
 - For 1.8V supply: 5PB1203, 5PB1204, 5PB1206
 - For 2.5V / 3.3V supply: 5PB1213, 5PB1214, 5PB1216
- Three, four, and six outputs with individual Output Enable pin
- One input
- OE_OSC control pin to enable/disable reference TCXO/XO
- Small 10-pin, 16-pin and 20-pin packages available
- Industrial -40° to +105°C temperature range

Block Diagram



Pin Assignments



Pin Descriptions

Pin Name	Pin Number			Pin Type	Pin Description
	5PB1203 5PB1213	5PB1204 5PB1214	5PB1206 5PB1216		
VDD	2	2, 7, 12	3, 9, 15	Power	Connect 1.8V to 5PB1203/5PB1204/5PB1206. Connect 2.5V or 3.3V to 5PB1213/5PB1214/5PB1216.
GND	1	3, 9, 14	4, 12, 18	Power	Power supply ground.
CLKIN	3	15	20	Input	Reference input pin. Connect to LVCMOS input or TCXO.
OE_OSC	4	6	8	Output	Input Crystal Oscillator enable pin. Follow Enable Function Truth Table. If all OE pins are low then OE_OSC is low. Otherwise OE_OSC is high, enabling reference crystal oscillator.
OE1	6	16	19	Input	Output Enable pin for CLKOUT1. Active High. Internal 120kΩ pull-down.
OE2	7	1	1	Input	Output Enable pin for CLKOUT2. Active High. Internal 120kΩ pull-down.
OE3	5	4	2	Input	Output Enable pin for CLKOUT3. Active High. Internal 120kΩ pull-down.
OE4	—	5	6	Input	Output Enable pin for CLKOUT4. Active High. Internal 120kΩ pull-down.
OE5	—	—	7	Input	Output Enable pin for CLKOUT5. Active High. Internal 120kΩ pull-down.
OE6	—	—	5	Input	Output Enable pin for CLKOUT6. Active High. Internal 120kΩ pull-down.
CLKOUT1	8	13	17	Output	Clock Output 1. Same frequency as CLKIN.
CLKOUT2	9	11	16	Output	Clock Output 2. Same frequency as CLKIN.
CLKOUT3	10	10	14	Output	Clock Output 3. Same frequency as CLKIN.
CLKOUT4	—	8	13	Output	Clock Output 4. Same frequency as CLKIN.
CLKOUT5	—	—	11	Output	Clock Output 5. Same frequency as CLKIN.
CLKOUT6	—	—	10	Output	Clock Output 6. Same frequency as CLKIN.

Enable Function Truth Table

Input						Output							
OE1	OE2	OE3	OE4	OE5	OE6	OE_OSC	CLKOUT1	CLKOUT2	CLKOUT3	CLKOUT4	CLKOUT5	CLKOUT6	
0	0	0	0	0	0	0	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	
1	0	0	0	0	0	1	CLOCK	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	
1	1	0	0	0	0	1	CLOCK	CLOCK	Hi-Z	Hi-Z	Hi-Z	Hi-Z	
...	...	...	...	...	...	...	...	...	...	...	...	...	
1	1	1	1	1	1	1	CLOCK	CLOCK	CLOCK	CLOCK	CLOCK	CLOCK	

External Components

A minimum number of external components are required for proper operation. A decoupling capacitor of 0.01μF should be connected between VDD on pin 1 and GND on pin 4, as close to the device as possible. A 33Ω series terminating resistor may be used on each clock output if the trace is longer than 1 inch.

To achieve the low output skew that the 5PB12xx is capable of, careful attention must be paid to board layout. Essentially, all four outputs must have identical terminations, identical loads and identical trace geometries. If they do not, the output skew will be degraded. For example, using a 30Ω series termination on one output (with 33Ω on the others) will cause at least 15ps of skew.

Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the 5PB12xx. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Item	Rating
Supply Voltage, VDD	3.8V
Output Enable and All Inputs/Outputs	-0.5 V to VDD + 0.5 V
Ambient Operating Temperature (extended)	-40 to +105°C
Storage Temperature	-65 to +150°C
Junction Temperature	125°C
Soldering Temperature	260°C

DC Electrical Characteristics

(VDD = 1.8V, 2.5V, 3.3V)

VDD = 1.8V ±5%, for **5PB1203 / 1204 / 1206**, ambient temperature -40° to +105°C, unless stated otherwise.

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Operating Voltage	VDD		1.71		1.89	V
Input High Voltage, CLKIN	V _{IH}	LVC MOS input. Note 1	VDD/2 + 200		VDD	mV
Input Low Voltage, CLKIN	V _{IL}	LVC MOS input. Note 1			VDD/2 - 200	mV
Input High Voltage, OE	V _{IH}		0.7xVDD		VDD	V
Input Low Voltage, OE	V _{IL}				0.3xVDD	V
Output High Voltage	V _{OH}	I _{OH} = -4mA	0.8xVDD			V
Output Low Voltage	V _{OL}	I _{OL} = 4mA			0.2xVDD	V
Nominal Output Impedance	Z _O			17		Ω
Input Capacitance	C _{IN}			5		pF
Operating Supply Current						
5PB1203	IDD	CLKIN = 26MHz, all outputs enabled		4.76	5.91	mA
		CLKIN = Low or High, all outputs disabled		0.01	0.01	
5PB1204		CLKIN = 26MHz, all outputs enabled		5.99	7.22	
		CLKIN = Low or High, all outputs disabled		0.01	0.01	
5PB1206		CLKIN = 26MHz, all outputs enabled		9.15	11.39	
		CLKIN = Low or High, all outputs disabled		0.01	0.01	

VDD = 2.5V ±5%, for **5PB1213 / 1214 / 1216**, ambient temperature -40° to +105°C, unless stated otherwise.

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Operating Voltage	VDD		2.375		2.625	V
Input High Voltage, CLKIN	V _{IH}	LVC MOS input. Note 1	VDD/2 + 200		VDD	mV
Input Low Voltage, CLKIN	V _{IL}	LVC MOS input. Note 1			VDD/2 - 200	mV
Input High Voltage, OE	V _{IH}		0.7xVDD		VDD	V
Input Low Voltage, OE	V _{IL}				0.3xVDD	V
Output High Voltage	V _{OH}	I _{OH} = -4mA	0.8xVDD			V
Output Low Voltage	V _{OL}	I _{OL} = 4mA			0.2xVDD	V
Nominal Output Impedance	Z _O			17		Ω
Input Capacitance	C _{IN}	ICLK, OE pin		5		pF
Operating Supply Current						
5PB1213	IDD	CLKIN = 26MHz, all outputs enabled		6.66	8.54	mA
		CLKIN = Low or High, all outputs disabled		0.01	0.02	
5PB1214		CLKIN = 26MHz, all outputs enabled		8.36	10.48	
		CLKIN = Low or High, all outputs disabled		0.01	0.03	
5PB1216		CLKIN = 26MHz, all outputs enabled		12.58	16.30	
		CLKIN = Low or High, all outputs disabled		0.01	0.04	

VDD = 3.3V ±5%, for **5PB1213 / 1214 / 1216**, ambient temperature -40° to +105°C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Operating Voltage	VDD		3.135		3.465	V
Input High Voltage, CLKIN	V _{IH}	LVC MOS input. Note 1	VDD/2 + 200		VDD	mV
Input Low Voltage, CLKIN	V _{IL}	LVC MOS input. Note 1			VDD/2 - 200	mV
Input High Voltage, OE	V _{IH}		0.7xVDD		VDD	V
Input Low Voltage, OE	V _{IL}				0.3xVDD	V
Output High Voltage	V _{OH}	I _{OH} = -4mA	0.8xVDD			V
Output Low Voltage	V _{OL}	I _{OL} = 4mA			0.2xVDD	V
Nominal Output Impedance	Z _O			17		Ω
Input Capacitance	C _{IN}	ICLK, OE pin		5		pF
Operating Supply Current						
5PB1213	IDD	CLKIN = 26MHz, all outputs enabled		8.96	11.65	mA
		CLKIN = Low or High, all outputs disabled		0.14	0.45	
5PB1214		CLKIN = 26MHz, all outputs enabled		11.34	14.06	
		CLKIN = Low or High, all outputs disabled		0.20	0.63	
5PB1216		CLKIN = 26MHz, all outputs enabled		16.87	21.72	
		CLKIN = Low or High, all outputs disabled		0.22	0.70	

Notes: 1. Nominal switching threshold is VDD/2.

AC Electrical Characteristics

(VDD = 1.8V, 2.5V, 3.3V)

VDD = 1.8V ±5%; for **5PB1203 / 1204 / 1206**, ambient Temperature -40° to +105°C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Input Frequency			0		200	MHz
Output Rise Time	t _{OR}	0.36 to 1.44V, C _L = 5pF		0.6	1.0	ns
Output Fall Time	t _{OF}	1.44 to 0.36V, C _L = 5pF		0.6	1.0	ns
Propagation Delay	Note 1	Note 1	1.5	2.0	2.5	ns
Buffer Additive Phase Jitter, RMS		26MHz TCXO clipped sine wave input, Integration Range: 12kHz to 20MHz		420		fs
		125MHz LVCMOS input, Integration Range: 12kHz to 20MHz		42		fs
Output to Output Skew	t _{SKEWO-O}	Note 2, Rising edges at VDD/2		20	50	ps
Device to Device Skew	t _{SKEWD-D}	Rising edges at VDD/2			200	ps
Delay for Output Enable / Disable Time ENABLEx to BCLKn	t _{EN} /t _{DIS}	CL < 5pF			3	cycles
Start-up Time	t _{START-UP}				2	ms
TCXO Clock Clipped Sine Wave Input Voltage Swing Level	V _{INpp}	VDD = 1.8V, should connect to CLKIN through AC coupling and bias circuit		0.8		V

VDD = 2.5V ±5%; for **5PB1213 / 1214 / 1216**, ambient Temperature -40° to +105°C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Input Frequency			0		200	MHz
Output Rise Time	t _{OR}	0.5 to 2.0V, C _L = 5pF		0.6	1.0	ns
Output Fall Time	t _{OF}	2.0 to 0.5V, C _L = 5pF		0.6	1.0	ns
Propagation Delay	Note 1	Note 1	1.7	2.2	2.7	ns
Buffer Additive Phase Jitter, RMS		26MHz TCXO clipped sine wave input, Integration Range: 12kHz to 20MHz		280		fs
		125MHz LVCMOS input, Integration Range: 12kHz to 20MHz		30		fs
Output to Output Skew	t _{SKEWO-O}	Note 2, Rising edges at VDD/2		20	50	ps
Device to Device Skew	t _{SKEWD-D}	Rising edges at VDD/2			200	ps
Delay for Output Enable / Disable Time ENABLEx to BCLKn	t _{EN} /t _{DIS}	CL < 5pF			3	cycles
Start-up Time	t _{START-UP}	Part start-up time for valid outputs after VDD ramp-up			2	ms
TCXO Clock Clipped Sine Wave Input Voltage Swing Level	V _{INpp}	VDD = 2.5V, should connect to CLKIN through AC coupling and bias circuit		0.8		V

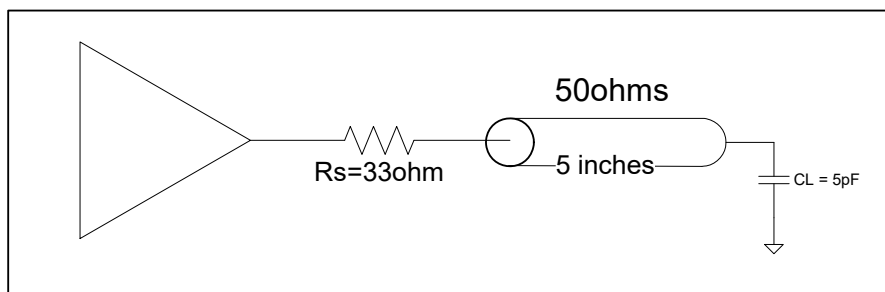
VDD = 3.3V ±5%; for 5PB1213 / 1214 / 1216, ambient Temperature -40° to +105°C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Input Frequency			0		200	MHz
Output Rise Time	t_{OR}	0.66 to 2.64V, $C_L = 5\text{pF}$		0.6	1.0	ns
Output Fall Time	t_{OF}	2.64 to 0.66V, $C_L = 5\text{pF}$		0.6	1.0	ns
Propagation Delay	Note 1	Note 1	1.4	1.9	2.4	ns
Buffer Additive Phase Jitter, RMS		26MHz TCXO clipped sine wave input, Integration Range: 12kHz to 20MHz		377		fs
		125MHz LVCMOS input, Integration Range: 12kHz to 20MHz		18		fs
Output to Output Skew	$t_{SKEWO-O}$	Note 2, Rising edges at VDD/2		20	50	ps
Device to Device Skew	$t_{SKEWD-D}$	Rising edges at VDD/2			200	ps
Delay for Output Enable / Disable Time ENABLEx to BCLKn	t_{EN}/t_{DIS}	$CL < 5\text{pF}$			3	cycles
Start-up Time	$t_{START-UP}$	Part start-up time for valid outputs after VDD ramp-up			2	ms
TCXO Clock Clipped Sine Wave Input Voltage Swing Level	$V_{IN_{pp}}$	VDD = 3.3V, should connect to CLKIN through AC coupling and bias circuit		0.5		V

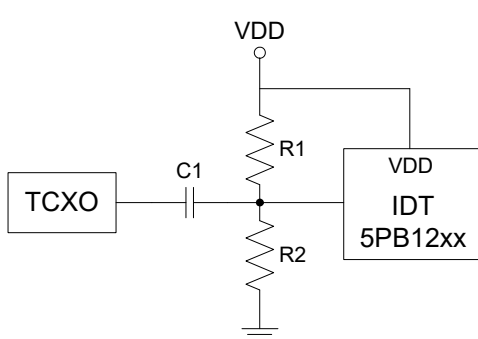
Notes:

1. With rail to rail input clock.
2. Between any 2 outputs with equal loading.
3. Duty cycle on outputs will match incoming clock duty cycle. Consult IDT for tight duty cycle clock generators.

Test Load and Circuit



AC Coupling and Bias Circuit



Component	Value
C1	0.1 μF
R1	10k
R2	10k

Package Outline Drawings

- 5PB1203 / 5PB1213 10-DFN
www.idt.com/document/psc/ntg10-package-outline-20-x-20-mm-body-075-mm-thick
- 5PB1204 / 5PB1214 16-VFQFPN
www.idt.com/document/psc/cmgl6-package-outline-drawing-25-x-25-x-05-mm-body-040mm-pitch-vfqfpn
- 5PB1206 / 5PB1216 20-pin VFQFPN
www.idt.com/document/psc/20-vfqfpn-package-outline-drawing-30-x-30-x-090-mm-040mm-pitch-165-x-165-mm-epad-ndg20p2

Ordering Information

Part / Order Number	Shipping Packaging	Package	Temperature
5PB1203NTGK	Cut Tape	10-pin DFN	-40 to +105°C
5PB1203NTGK8	Tape and Reel	10-pin DFN	-40 to +105°C
5PB1213NTGK	Cut Tape	10-pin DFN	-40 to +105°C
5PB1213NTGK8	Tape and Reel	10-pin DFN	-40 to +105°C
5PB1204CMGK	Cut Tape	16-pin VFQFPN	-40 to +105°C
5PB1204CMGK8	Tape and Reel	16-pin VFQFPN	-40 to +105°C
5PB1214CMGK	Cut Tape	16-pin VFQFPN	-40 to +105°C
5PB1214CMGK8	Tape and Reel	16-pin VFQFPN	-40 to +105°C
5PB1206NDGK	Tube	20-pin VFQFPN	-40 to +105°C
5PB1206NDGK8	Tape and Reel	20-pin VFQFPN	-40 to +105°C
5PB1216NDGK	Tube	20-pin VFQFPN	-40 to +105°C
5PB1216NDGK8	Tape and Reel	20-pin VFQFPN	-40 to +105°C

“G” after the two-letter package code denotes Pb-Free configuration, RoHS compliant.

Marking Diagrams

203K YW** 10-pin DFN	204K Y** 16-pin VFQFPN	XXX YWW\$ 206K 20-pin VFQFPN
213K YW** 10-pin DFN	214K Y** 16-pin VFQFPN	XXX YWW\$ 216K 20-pin VFQFPN

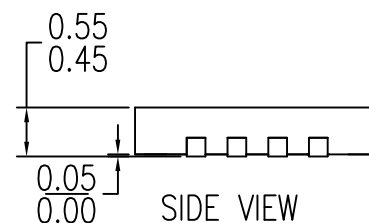
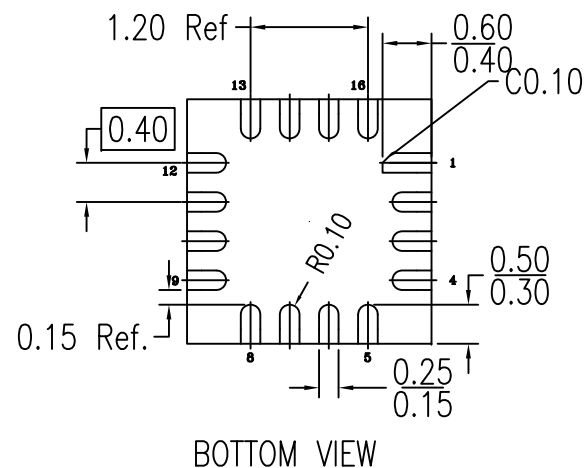
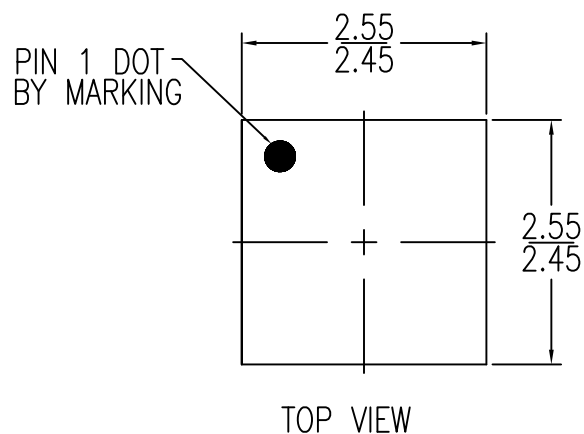
Notes:

- “**” is the lot number.
- “YWW”, “YW”, or “Y” are the last digit(s) of the year and week that the part was assembled.
- “\$” denotes mark code.
- “K” denotes extended temperature range device.
- “XXX” denotes last three characters of Asm lot.

Revision History

Date	Description of Change
February 3, 2020	Updated the capacitor value for C1 in AC Coupling and Bias Circuit
November 22, 2019	- Updated "Operating Supply Current" data in DC Electrical Characteristics for VDD = 1.8V $\pm$5%, VDD = 2.5V $\pm$5%, and VDD = 3.3V $\pm$5% - Updated Package Outline Drawings; however, no mechanical changes
February 28, 2018	- Updated CLKIN input high and low voltage ratings in DC characterization tables. - Updated Absolute Maximum supply voltage (VDD) from 3.465V to 3.8V.
April 10, 2017	- Updated Operating Supply Current and Operating Voltage values in DC electrical characteristics tables. - Updated Propagation Delay and Output skew values in AC electrical characteristics tables. - Updated package outline drawings. - Updated legal disclaimer.
July 11, 2016	Initial release.

REVISIONS			
DATE CREATED	REV	DESCRIPTION	AUTHOR
4/3/14	00	INITIAL RELEASE	JH
12/11/14	01	ADD PIN1 CHAMFER	JH
4/5/18	02	CHANGE QFN TO VFQFPN, RECALCULATE LAND PATTERN	RC
NOE: REFER TO DCP FOR OFFICIAL RELEASE DATE			

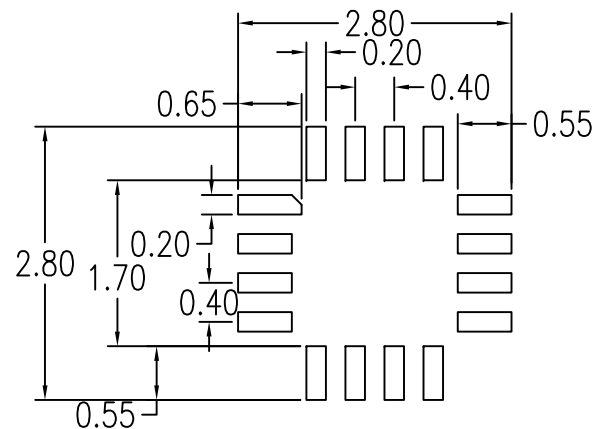


NOTES:

1. ALL DIMENSIONING AND TOLERANCING CONFORM TO ANSI Y14.5M-1982
2. ALL DIMENSIONS ARE IN MILLIMETERS.

TOLERANCES UNLESS SPECIFIED DECIMAL ANGULAR X± ±1° XX± XXX±		 IDT™ 6024 Silver Creek Valley Road San Jose CA 95138 PHONE: (408) 284-8200 FAX: (408) 284-8591 www.IDT.com	
DRAWN		TITLE CMG16 Package Outline Drawing 2.5 x 2.5 x 0.5 mm Body 0.40mm Pitch VFQFPN	
		SIZE C	DRAWING No. PSC-4478 REV 02
DO NOT SCALE DRAWING			SHEET 1 OF 2

REVISIONS			
DATE CREATED	REV	DESCRIPTION	AUTHOR
4/3/14	00	INITIAL RELEASE	JH
12/11/14	01	ADD PIN1 CHAMFER	JH
4/5/18	02	CHANGE QFN TO VFQFPN, RECALCULATE LAND PATTERN	RC
NOE: REFER TO DCP FOR OFFICIAL RELEASE DATE			

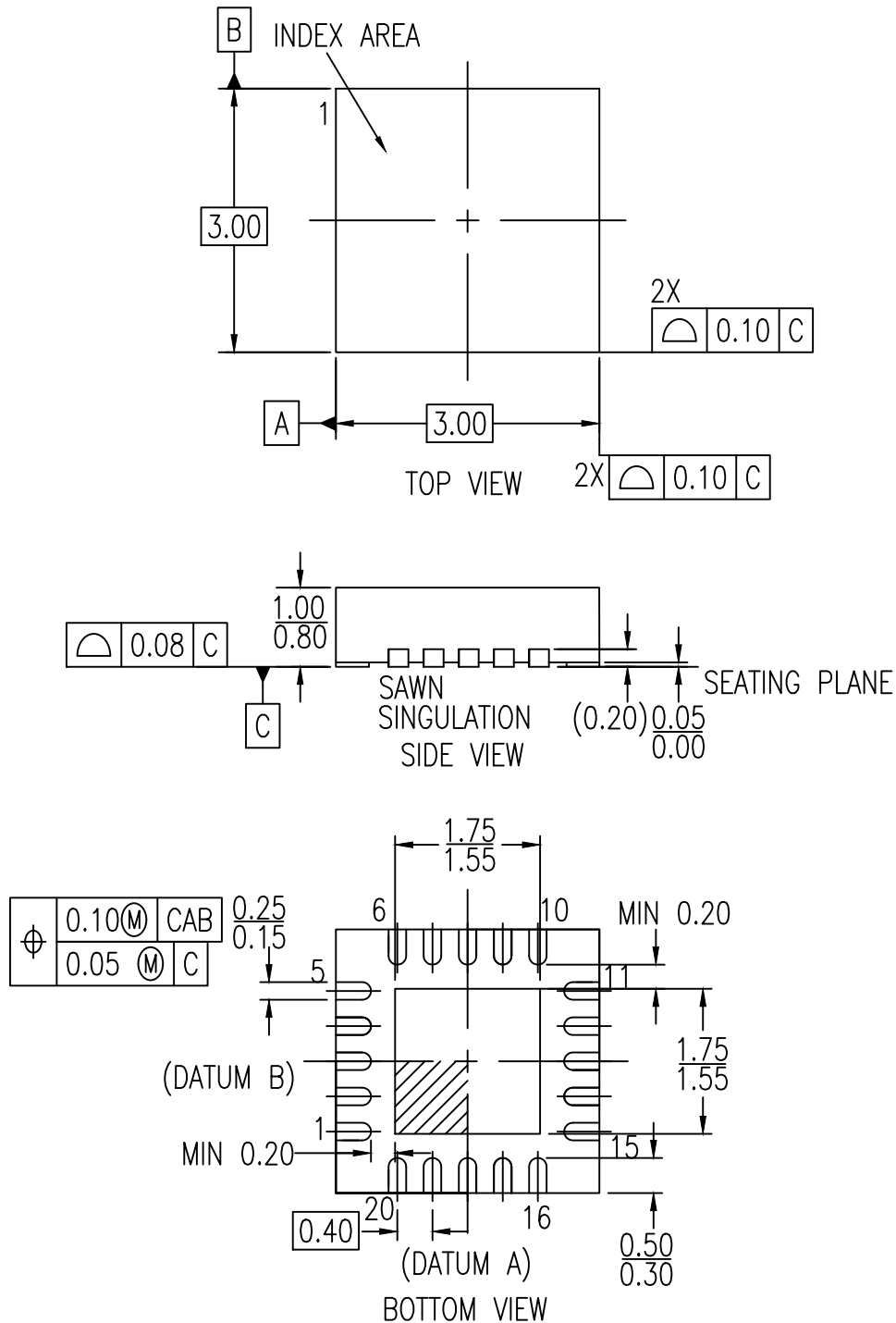


RECOMMENDED LAND PATTERN DIMENSION

NOTES:

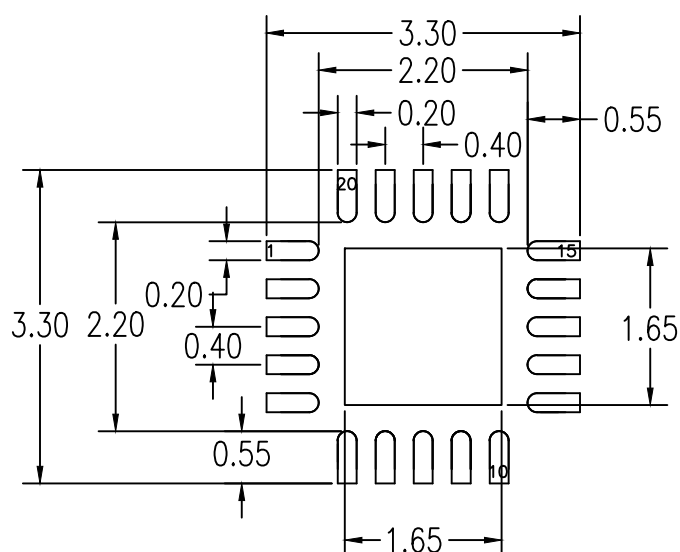
1. ALL DIMENSIONS ARE IN MM. ANGLES IN DEGREES.
2. TOP DOWN VIEW AS VIEWED ON PCB.
3. LAND PATTERN RECOMMENDATION PER IPC-7351B GENERIC REQUIREMENT FOR SURFACE MOUNT DESIGN AND LAND PATTERN.

TOLERANCES UNLESS SPECIFIED		 IDT™ 6024 Silver Creek Valley Road San Jose CA 95138 PHONE: (408) 284-8200 FAX: (408) 284-8591 www.IDT.com	
DECIMAL	ANGULAR		
X±	±1°	TITLE CMG16 Package Outline Drawing 2.5 x 2.5 x 0.5 mm Body 0.40mm Pitch VFQFPN	
XX±			
XXX±		SIZE C DRAWING No. PSC-4478 REV 02	
DRAWN		DO NOT SCALE DRAWING SHEET 2 OF 2	



NOTE:

1. ALL DIMENSIONS ARE IN MM.
2. ALL DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5-2009
3. PIN 1 LOCATION IDENTIFIER IS EITHER BY CHAMFER OR NOTCH



RECOMMENDED LAND PATTERN DIMENSION

NOTES:

1. ALL DIMENSIONS ARE IN MM. ANGLES IN DEGREES.
2. TOP DOWN VIEW. AS VIEWED ON PCB.
3. LAND PATTERN RECOMMENDATION PER IPC-7351B GENERIC REQUIREMENT FOR SURFACE MOUNT DESIGN AND LAND PATTERN.

Package Revision History		
Date Created	Rev No.	Description
Sept 13, 2018	Rev 01	Change QFN to VFQFPN
Mar 30, 2016	Rev 00	Initial Release

IMPORTANT NOTICE AND DISCLAIMER

RENESAS ELECTRONICS CORPORATION AND ITS SUBSIDIARIES ("RENESAS") PROVIDES TECHNICAL SPECIFICATIONS AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS OR IMPLIED, INCLUDING, WITHOUT LIMITATION, ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for developers skilled in the art designing with Renesas products. You are solely responsible for (1) selecting the appropriate products for your application, (2) designing, validating, and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. Renesas grants you permission to use these resources only for development of an application that uses Renesas products. Other reproduction or use of these resources is strictly prohibited. No license is granted to any other Renesas intellectual property or to any third party intellectual property. Renesas disclaims responsibility for, and you will fully indemnify Renesas and its representatives against, any claims, damages, costs, losses, or liabilities arising out of your use of these resources. Renesas' products are provided only subject to Renesas' Terms and Conditions of Sale or other applicable terms agreed to in writing. No use of any Renesas resources expands or otherwise alters any applicable warranties or warranty disclaimers for these products.

(Rev.1.0 Mar 2020)

Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu,
Koto-ku, Tokyo 135-0061, Japan
www.renesas.com

Contact Information

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit:
www.renesas.com/contact/

Trademarks

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Renesas Electronics:

[5PB1203NTGK](#) [5PB1206NDGK8](#) [5PB1204CMGK](#) [5PB1213NTGK8](#) [5PB1203NTGK8](#) [5PB1204CMGK8](#)
[5PB1214CMGK](#) [5PB1216NDGK](#) [5PB1213NTGK](#) [5PB1216NDGK8](#) [5PB1206NDGK](#) [5PB1214CMGK8](#)